

Article

Control of the Microstructure in a $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ High Entropy Alloy through Thermo-Mechanical and Thermal Treatments

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Abstract: The effect of thermo-mechanical processing and thermal treatments on the microstructure of a single phase fcc-based $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ high entropy alloy is evaluated in this study. As-cast ingots of the high entropy alloy were thermo-mechanically processed following different routes involving forging, cold rolling, warm rolling or hot rolling. In addition, the microstructural evolution of highly deformed cold rolled sheets with the annealing temperature was analyzed. The data reveal that a high-volume fraction of the microstructure commences to recrystallize from 600 °C. In the absence of recrystallization, i.e., below 600 °C, the hardness of thermo-mechanically processed and annealed samples was very close. When recrystallization takes place, the thermo-mechanically treated alloys exhibit higher hardness than the annealed alloys because the recrystallized grains are strengthened by dislocations generated in further steps of the processing while the alloys in the annealed condition are free of dislocations. Maximum hardening is found for the alloy warm-rolled at 450 °C and the alloy cold-rolled plus annealing at 500 °C for 1 h. Diffusion of solute atoms to the core of dislocations, pinning its movement, accounts for the additional hardening.

Keywords: high-entropy alloys; processing routes; annealing; microstructural evolution; hardness



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1. Introduction

High-entropy alloys (HEAs) are considered as potential candidates as structural materials for high-temperature applications because of their inherent properties. It is expected that the distortion induced by elements with different sizes as well as microstructural stability due to slowing down of the diffusion phenomenon compared with conventional alloys can provide enhanced creep resistance to this kind of alloy [1–4]. Most single-phase HEAs reported in the literature based on transition metals have mostly a cubic structure, face centered (fcc) or body centered (bcc) structure, while the number of HEAs with hexagonal structures is much lower [1–4]. From the point of view of their mechanical properties, HEAs' compositions with bcc structures provide very high strengths, but they are very often brittle [5]. On the other hand, HEAs based on the fcc structure are much softer than bcc-based HEAs, but they exhibit high ductility [5]. Most of the research regarding mechanical properties of fcc-based HEAs, however, was developed in alloys whose compositions are close to equiatomic, commonly containing other strengthening phases such as intermetallic compounds and/or bcc phases.

Extensive work regarding the influence of thermo-mechanical processing and thermal treatments in these multiphase fcc-based HEAs is currently in progress as a way for maximizing their strengths [6–12]. On the contrary, less attention has been dedicated to thermo-mechanical processing of fcc-based single-phase HEAs because their mechanical properties are lower than those of multiphase fcc-based HEAs. In fact, many results are reported for

coarse-grained as-cast materials, which would lead to the frequently low yield strengths reported in the literature [5]. Nevertheless, the microstructure of these alloys could be conveniently refined through the proper design of the processing route [13–19]. Most of the research in this field was mainly accomplished in equiatomic alloys, showing that the yield strength/ductility of these alloys can be considerably increased through the proper optimization of thermo-mechanical processing [13,14] and/or thermal treatments [15–17]. In the present work, the influence of the processing route and annealing temperature on the microstructure and hardness of the single-phase fcc-based $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ HEA was studied. The effect of annealing temperature was evaluated on cold-rolled sheets.

2. Materials and Methods

The nominal composition of the HEA, given in atomic percentage, is $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ (see Table 1). The proper amounts of pure commercially available elements were melted in an induction furnace under a protective argon atmosphere for preventing oxidation phenomena. The purity of the different elements was: electrolytic cobalt was 99.95 wt.%; aluminothermic chromium was 99.32 wt.% (containing as main impurities 0.23% Fe and 0.14Al); electrolytic nickel was 99.92 wt.%; iron was 99.63 wt.%; and aluminum was 99.95 wt.%. The elements were heated up to 1700 °C in 15 min, and then this temperature was maintained for 10 min for assuring good homogeneity in the melt prior to pouring it into a cylindrical copper mold. The ingots were subjected to several thermo-mechanical treatments as a way for modifying the coarse-grained microstructure of the as-cast condition (see Table 2). This includes hot forging at 1200 °C, cold rolling at room temperature, warm rolling at 450 °C and hot rolling at 850 °C. Forging was conducted in a single stage. Parallelepiped was machined from the cylindrical ingots with sizes of $100 \times 30 \times 7$ and $100 \times 50 \times 12 \text{ mm}^3$ for cold rolling and 450 °C/850 °C rolling, respectively. The reduction per pass was 0.5 mm during cold rolling, 1 mm for warm rolling at 450 °C and 1.5 mm for hot rolling at 850 °C. During rolling at 450 and 850 °C, the sheets were put again in the furnace after each single pass as a way to keep the temperature constant over the entire rolling process. This procedure was followed until completing the overall sheet reduction (final thicknesses are also given in Table 2). The microstructural evolution of cold-rolled sheets during annealing for 1 h in the temperature range 400–950 °C was equally studied (the different thermal treatments are listed in Table 3).

Table 1. Real composition, given in atomic percentage, of the HEA ingot in the as-cast condition determined from at least five EDS measurements.

Composition	Al	Co	Cr	Co	Ni
Nominal	5	15	30	25	25
Real	4.6 ± 0.1	15.9 ± 0.3	31.1 ± 0.3	24.1 ± 0.1	24.3 ± 0.2

Table 2. List of thermo-mechanical treatments performed over the as-cast ingots.

Condition	Temperature (°C)	Designation	Reduction (%)	Final Thickness (mm)
Forging	1200	FG1200	50 (1 step)	30
Cold rolling	25	CR	86 (0.5 mm per pass)	1
Warm rolling	450	WR450-2	83 (1 mm per pass)	2
Hot rolling	850	HR850-6	50 (1.5 mm per pass)	6
Hot rolling	850	HR850-2	83 (1.5 mm per pass)	2

Table 3. Temperatures applied during annealing for 1 h of cold rolled sheets.

Temperature (°C)	Designation
400	CR + TT400
500	CR + TT500
600	CR + TT600
700	CR + TT700
800	CR + TT800
850	CR + TT850
900	CR + TT900
950	CR + TT950

Microstructural characterization of materials was performed through the Electron Backscattered Diffraction (EBSD) technique coupled in a JEOL JSM 6500F (JEOL, Tokyo, Japan) field emission Scanning Electron Microscope (SEM). Collected EBSD data were analyzed using the Channel 5 software (Oxford Instruments, Oxford, UK) for obtaining the image quality (IQ) and the inverse pole figure (IPF) maps. The scanned area and the step size at which the different maps were recorded are given in their corresponding figure captions.

The variation of mechanical properties with the different treatments was evaluated through Vickers microhardness maintaining 15 s a load of 9.8 N. At least 8 measurements were performed at different regions of the samples

3. Results and Discussion

3.1. As-Cast Material

The microstructure of the alloy in the as-cast condition is shown in Figure 1. A single-phase structure consisting of coarse inhomogeneous equiaxed grains, whose size ranges from 150 to 550 μm , is observed. Most of the grain boundaries are high-angle, but also certain grains separated by low-angle boundaries are also present. Misorientation within the grains is practically absent, so it can be considered that the microstructure is free of deformation.

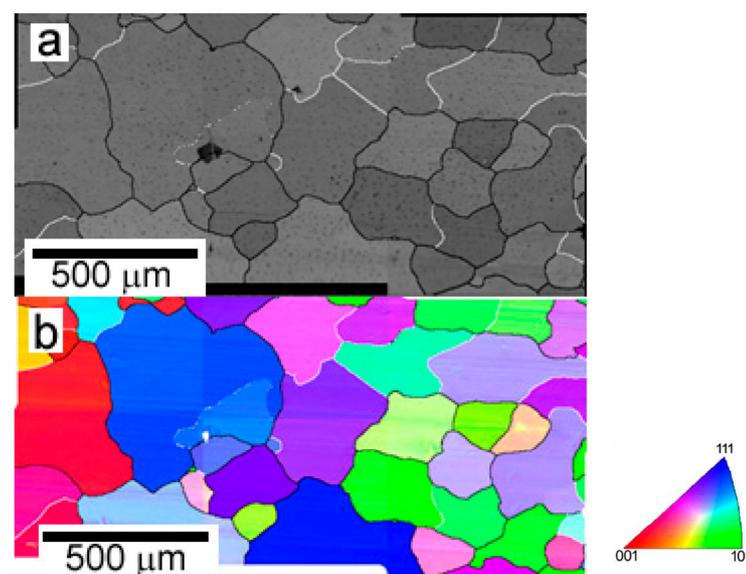


Figure 1. Microstructure of the $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ HEA in the as-cast condition obtained from EBSD measurements. (a) IQ, (b) IPF + IQ map. The scanned area is $1730 \times 860 \mu\text{m}^2$, and the step size is $2.5 \mu\text{m}$. White lines represent low-angle boundaries ($<4^\circ$).

3.2. Thermomechanical Processing

The microstructure of the as-cast alloy evolves during forging at 1200 °C, as shown in Figure 2. During forging, the piece flows perpendicularly to the applied load. As result, the grains are no longer equiaxed, but elongated. The grains are up to 650 μm long and about 150–175 μm wide. The deformation introduced during the forging promotes the occurrence of dynamic recrystallization (DRX) at certain grain boundaries/triple points of the original parent grains. Although the size of DRXed grains is much smaller than that of the original grains, the high temperature of the forging process which can even extend during the earliest stages of the cooling down results in a considerable grain growth in such a way that most of the DRXed grains ranges between 40 and 50 μm . Many of these new recrystallized grains contain also recrystallization twins (examples of them are marked by black arrows in Figure 2b). Compared to the as-cast microstructure, it is interesting to note the increase in misorientation within non-recrystallized grains, although large differences can be found depending on the orientation of the grains.

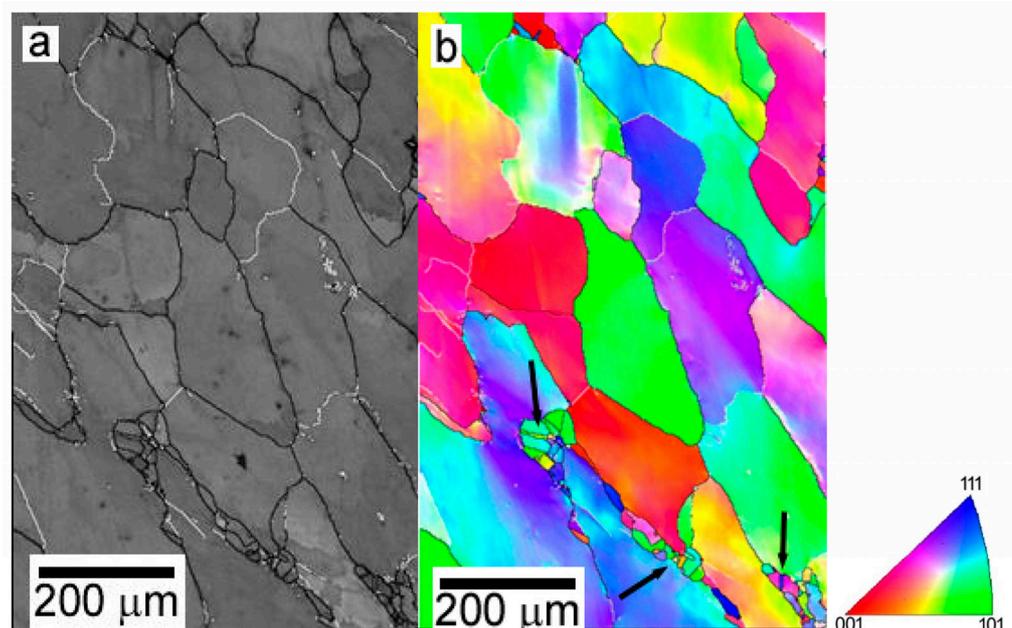


Figure 2. Microstructure of FG1200 HEA. The map was taken in a section perpendicular to the forging direction. (a) IQ and (b) IPF+IQ map. The scanned area is $600 \times 872 \mu\text{m}^2$; the step size is 2 μm . The black arrows mark twins within the recrystallized grains.

The as-cast ingot could be cold-rolled at room temperature with a reduction of 83% without any cracking. The initial grains are highly elongated along the rolling direction. IQ and IPF + IQ images reveal large distortions induced during the rolling process over the entire grain, which are significantly magnified within the bands distributed throughout the grain (Figure 3). It can be checked the existence of many regions in which the orientation is slightly deviated from that of the (111) plane of the parent grain. The numerous high-angle grain boundaries (HAGBs) within the parent grains usually define elongated regions with similar orientations which could be ascribed to deformation twins, as those reported during cold-rolling of numerous single phase fcc-HEAs [20–22]. On the other hand, an abrupt change in the orientation of the parent grain is found within the bands, exhibiting normally these regions a (101) orientation. Moreover, there is a fine dispersion of small domains exhibiting different orientations embedded in the bands, which could be considered as recrystallized grains. This means that inside the bands the strain becomes concentrated enough to induce huge local changes in orientation within the parent grains (see Figure 3).

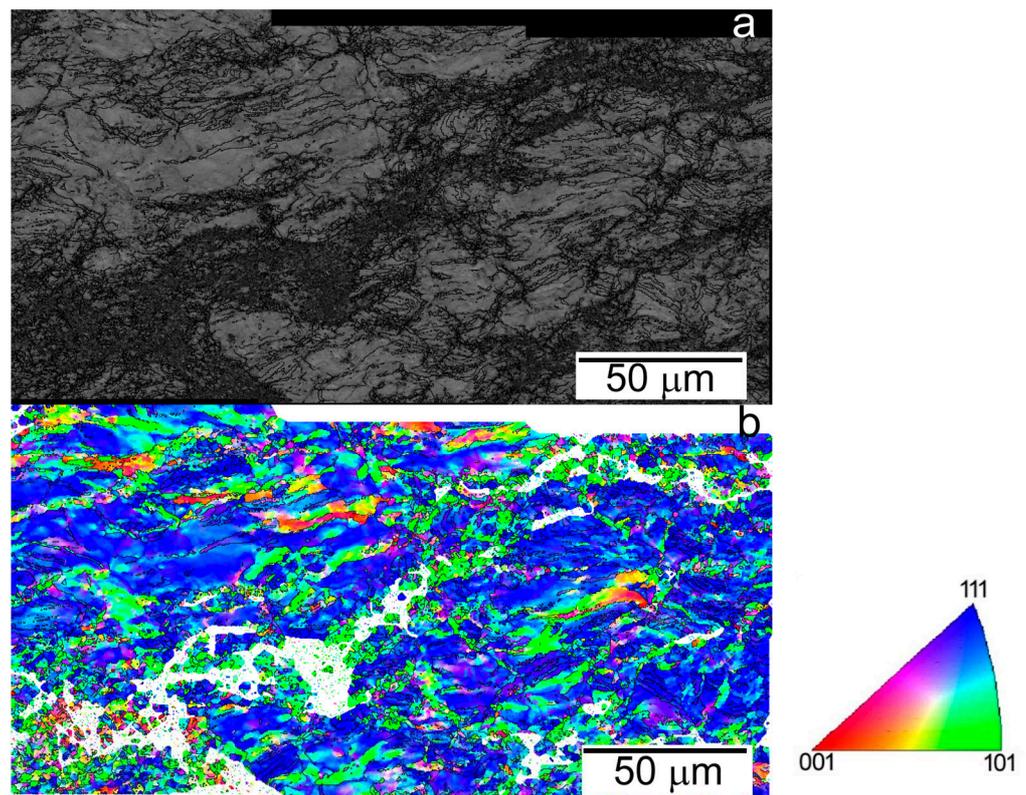


Figure 3. Detail of the microstructure inside an individual grain of the CR HEA, (a) IQ, (b) IPF + IQ map. The scanned area is $233 \times 122 \mu\text{m}^2$, and the step size is $0.3 \mu\text{m}$.

The microstructure of the sheet rolled at $450 \text{ }^\circ\text{C}$ resembles, in some way, that observed in the CR alloy. Thus, the parent grains remain highly elongated along the rolling direction although the dislocation density inside them seems to be lower than that found in the CR alloy (see Figure 4). Probably, re-heating during intermediate rolling steps, for assuring the $450 \text{ }^\circ\text{C}$ temperature through the overall rolling process, assists certain dislocation annihilation through recovery processes. Anyway, also, drastic changes in orientation are found within the parent grains, as found in the CR alloy. Unlike the CR material, elongation of coarse grains along the rolling direction is not well defined because the microstructure of the alloy consists of a combination of fine-grained regions embedded in coarse-grained regions which maintain the orientation of the parent grains. Moreover, a wide range of sizes can be distinguished within the fine-grained regions: (1) Recrystallized grains with an average grain size of about $1 \mu\text{m}$, resulting from the high strain stored in local regions of the alloy as those existing in the CR material and (2) larger grains up to $10\text{--}15 \mu\text{m}$ in size, outlined by high-angle grain boundaries. In both cases, their orientations are far from that of the parent grain. This suggests that the strain in these regions is not enough for inducing the nucleation of new grains but it is enough for causing large local changes in orientation which leads to the formation of new grains through bulging and subdivision processes within the parent grains.

Figure 5 shows the microstructure of the alloy warm rolled at $850 \text{ }^\circ\text{C}$ with a total reduction of 50%. A bimodal microstructure can be clearly observed; coarse elongated and fine equiaxed grains. During initial stages of rolling, coarse equiaxed grains existing in the as-cast ingot deform along the rolling direction. Nevertheless, the deformation becomes inhomogeneous as the rolling proceeds, which depends on the initial orientation of the equiaxed grains existing in the as-cast ingots. Such microstructural evolution arises from the occurrence or not of DRX. If the strain accumulated within the coarse elongated grains does not exceed a critical value, no DRX takes place. Deformation introduced during rolling just causes slight changes in orientation inside the grain, usually not larger than

$3\text{--}4^\circ$ among neighbor points, which affect the overall grain and lead to the development of large subgrains (see Figure 5). When the strain accumulated within the elongated grains exceeds a critical value, DRX takes place, leading to an equiaxed fine-grained structure. Moreover, the uneven distribution of stresses between adjacent grains also influences the local strain distribution within the coarse-non-DRXed grains. Thus, misorientation between opposite grain boundaries of coarse elongated grains becomes up to $15\text{--}17^\circ$, which changes gradually from one border to the other. Figure 6 presents a detail of the DRXed grains' regions. The grain sizes range from 5 to 25 μm , and recrystallization twins are often found, although not exclusively, within the coarsest grains. It is interesting to note the misorientation zones inside the DRXed grains. This indicates that DRXed grains undergo additional deformation during subsequent rolling steps.

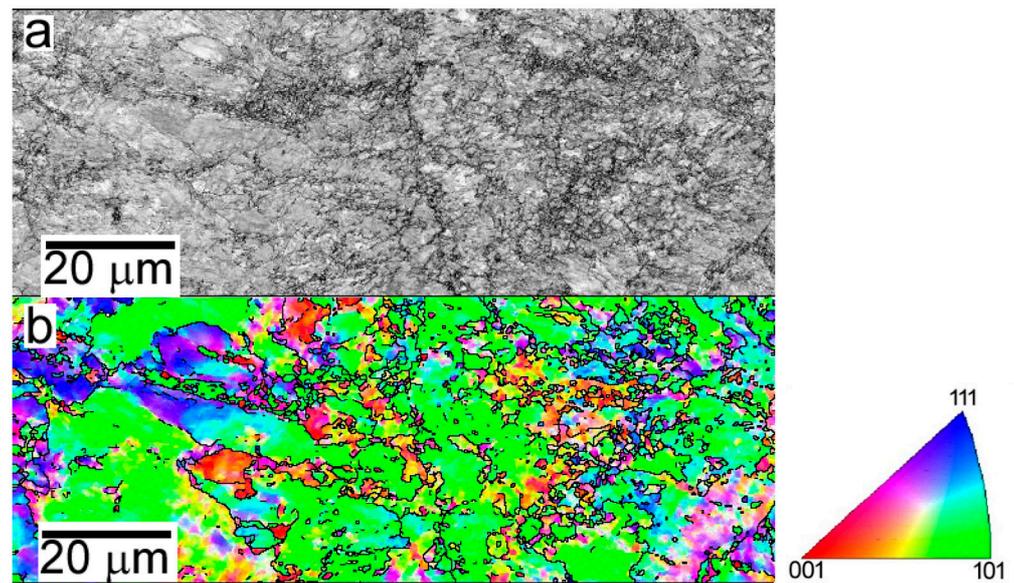


Figure 4. Detail of the microstructure inside a single grain of the WR450-2 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $118 \times 45 \text{ mm}^2$, and the step size is 0.2 μm .

The microstructure of the rolled sheet changes drastically if rolling continues until completing a total reduction of 83%. In this case, the entire microstructure corresponds to DRXed grains, although the grain size is rather heterogeneous because of the coexistence of coarse and fine grains (see Figure 7). Thus, the grain size oscillates between 5 and 40 μm and as a general rule is finer than that of DRXed grains in the HR850-6 material. Numerous recrystallization twins are found disregarding the size of DRXed grains. The low resolution of the grains in the IQ image indicates that the microstructure is highly deformed, more than the DRXed grains in the HR850-6 material. This assumption is corroborated in the IPF + IQ map, where clear orientation changes are noticed inside the DRXed grains. In addition, a low fraction of very small grains of about 1–2 μm appears at grain boundaries of DRXed grains (see encircled areas in Figure 7b). This suggests that deformation introduced in some DRXed grains during successive rolling is enough to promote the nucleation of new secondary DRXed grains, mainly at grain boundaries of the primary DRXed grains.

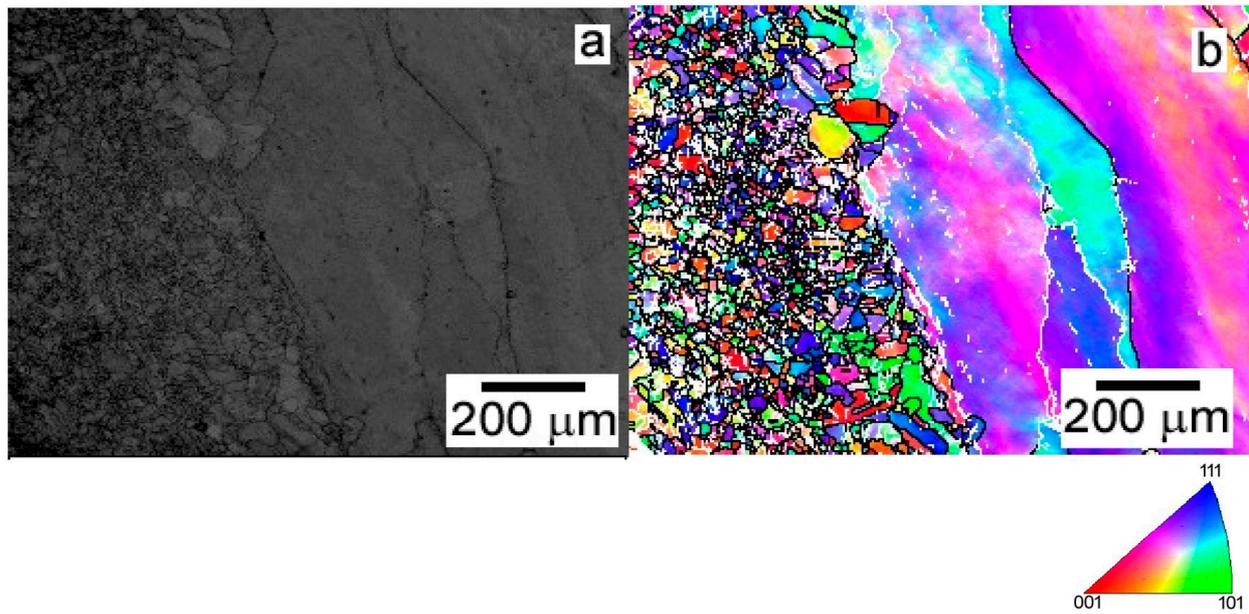


Figure 5. General view of the microstructure corresponding to the HR850-6 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $1196 \times 890 \mu\text{m}^2$, and the step size is $4 \mu\text{m}$.

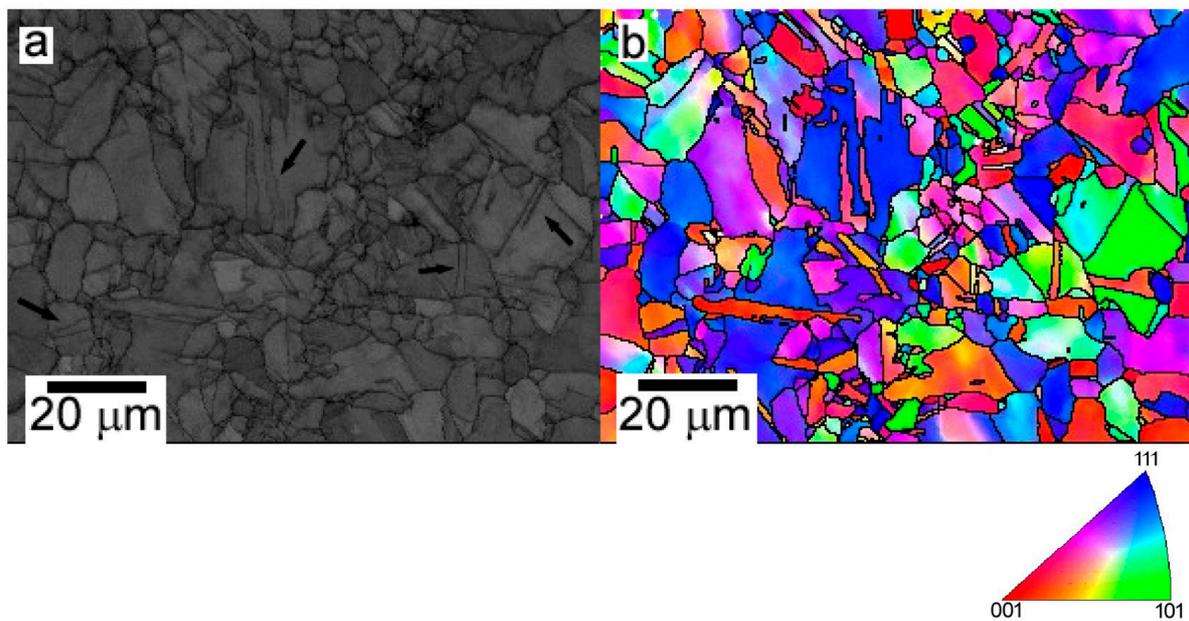


Figure 6. Detail of the equiaxed fine-grained region of the HR850-6 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $120 \times 89 \mu\text{m}^2$, and the step size is $0.4 \mu\text{m}$. The black arrows indicate some examples of recrystallization twins.

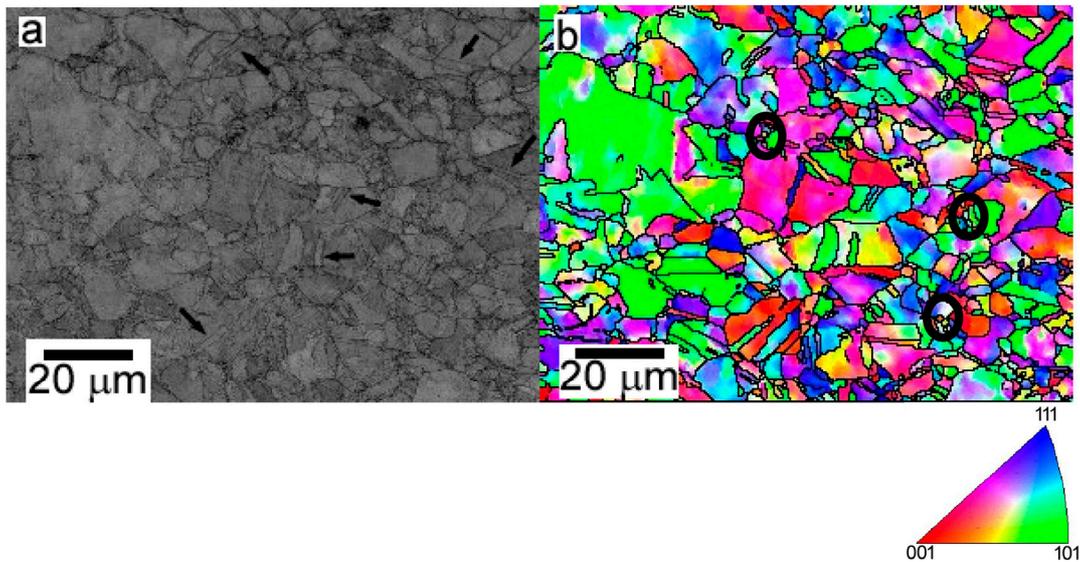


Figure 7. Detail of the microstructure of the HR850-2 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $120 \times 89 \mu\text{m}^2$, and the step size is $0.4 \mu\text{m}$. The black arrows indicate some examples of recrystallization twins. Encircled areas indicate new grains formed at grain boundaries of certain DRXed grains.

3.3. Annealing of CR Sheets

Figure 8 presents the microstructure of the CR alloy after annealing for 1 h at 500°C . The coarse-grained structure of the CR alloy is kept, but the IQ image reveals the absence of the large bands where the deformation was markedly concentrated, although there are still highly deformed regions whose orientations are far from that of the parent grain. In these regions, even, some small grains are recognized, which probably could correspond with the smallest grains existing in the CR alloy as a result of bulging and subdivision processes. A major part of the parent grain consists of a substructure constituted by almost parallel narrow bands which are instead subdivided into more or less equiaxed subgrains. This suggests that both annihilation of dislocations and accumulation of dislocations to develop low angle boundaries (LAB) account for the observed microstructure.

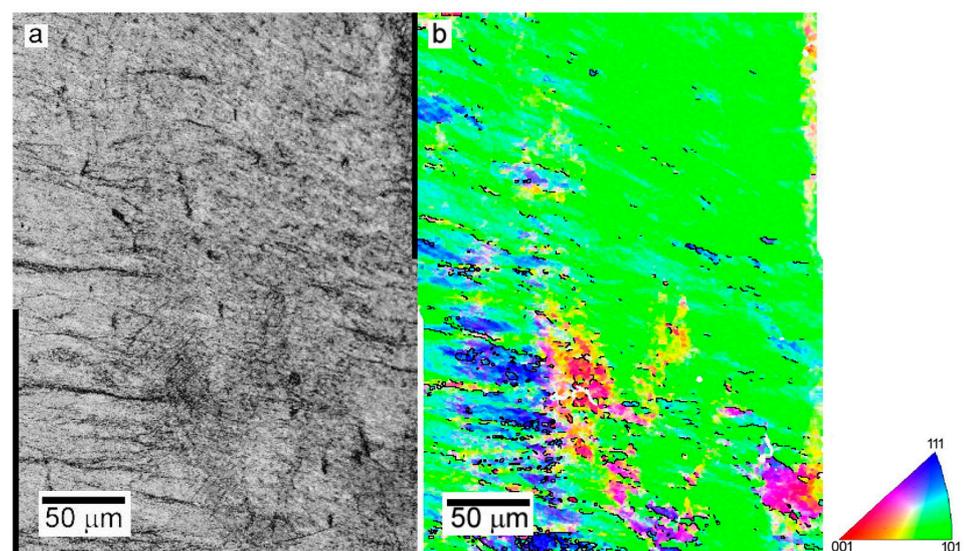


Figure 8. Detail of the microstructure of the CR + TT500 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $243 \times 330 \mu\text{m}^2$, and the step size is $0.7 \mu\text{m}$. Green color depicts the orientation of the parent grain.

The microstructure of the CR sheet evolves significantly when the temperature of annealing is increased to 600 °C. After 1 h of annealing, the volume fraction of regions maintaining the orientation of the parent grain decreased drastically while the fraction of regions with different orientations increased considerably with respect to that observed during the annealing at 500 °C (see Figure 9). Most of these misoriented regions appear as long grains with serrated HAGBs within the parent grains. The irregular morphology of these new grains suggests that the continuous accumulation of dislocations at certain subgrain boundaries increased the misorientation with respect to their corresponding parent grains, leading to the formation of new grains [23]. However, some misorientation is still noticed within these recrystallized grains, which is an indication that not all the dislocations were absorbed in the low-angle grain boundaries (LAGBs) to transform into HAGBs. In addition, very few fine equiaxed grains can be sparsely distributed through the entire parent grain. Probably, these small grains arise from the nucleation of new grains in highly deformed regions preexisting in the CR alloy, which hardly grow at this low temperature.

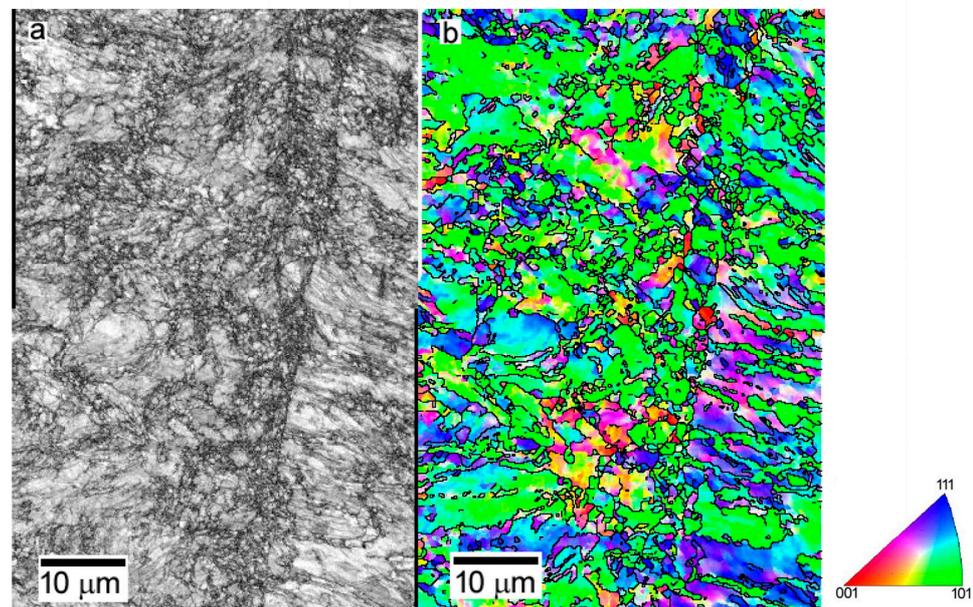


Figure 9. Detail of the microstructure of the CR + TT600 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $48 \times 72 \mu\text{m}^2$, and the step size is $0.15 \mu\text{m}$. Green color depicts the orientation of the parent grain.

The microstructure of the alloy after annealing at 700 °C is presented in Figure 10. The strongly deformed structure of the CR material statically recrystallized as equiaxed grains, not retaining any vestige of the coarse elongated parent grains. Therefore, 700 °C can be considered as the minimum temperature at which an equiaxed fine-grained microstructure can be readily developed after short annealing times. However, there is a large dispersion in grain sizes. Coarse- and fine-grained regions can be distinguished. In the first ones, the grain size ranges between 6 and 25 μm while the grain size varies between 1 and 3 μm in the second ones. Fine-grained regions are usually located as long strips separating the different coarse-grained regions. Recrystallization twins are observed profusely at both grain size distributions. The bimodal distribution can be correlated with the inhomogeneous distribution of the deformation inside the parent grains of the CR alloy. Thus, nucleation of new grains will start in those regions where deformation is accumulated while in other regions the beginning of recrystallization will be delayed. Consequently, further grain growth will proceed firstly where the new grains are nucleated, leading to coarse-grained areas, whereas nucleation of new statically recrystallized grains will render the fine-grained areas simultaneously. Annealing twins are usually considered

to be caused by a stacking error when a grain boundary is migrating [24], although other theories propose that they are generated when the grain boundary hardly advances in the deformed region because of its low dislocation density and/or low misorientation angle. In any case, stagnant grains cannot continue to grow because the driving force was insufficient for boundary migration. At this point, twin formation alters the misorientation angle in such a way that grain growth can resume [25]. The density of twins is larger in fine-grained regions, frequently dividing completely the recrystallized grain in two halves. In coarse-grained regions, however, the size of the twins is smaller compared to the grains in which they are contained. This indicates that coarse grains can grow rapidly due to the high dislocation density in their surroundings, so no twin formation is required until their growth overlaps with the growth of other grains. Otherwise, the grain growth is rapidly arrested in fine-grained regions because all nuclei are formed almost simultaneously. Since the dislocation density decreases sharply, the growth of these new recrystallized grains would slow down. At this point, twin formation provides the boundary energy for further growth at those positions where the driving force for grain boundary migration is low [25].

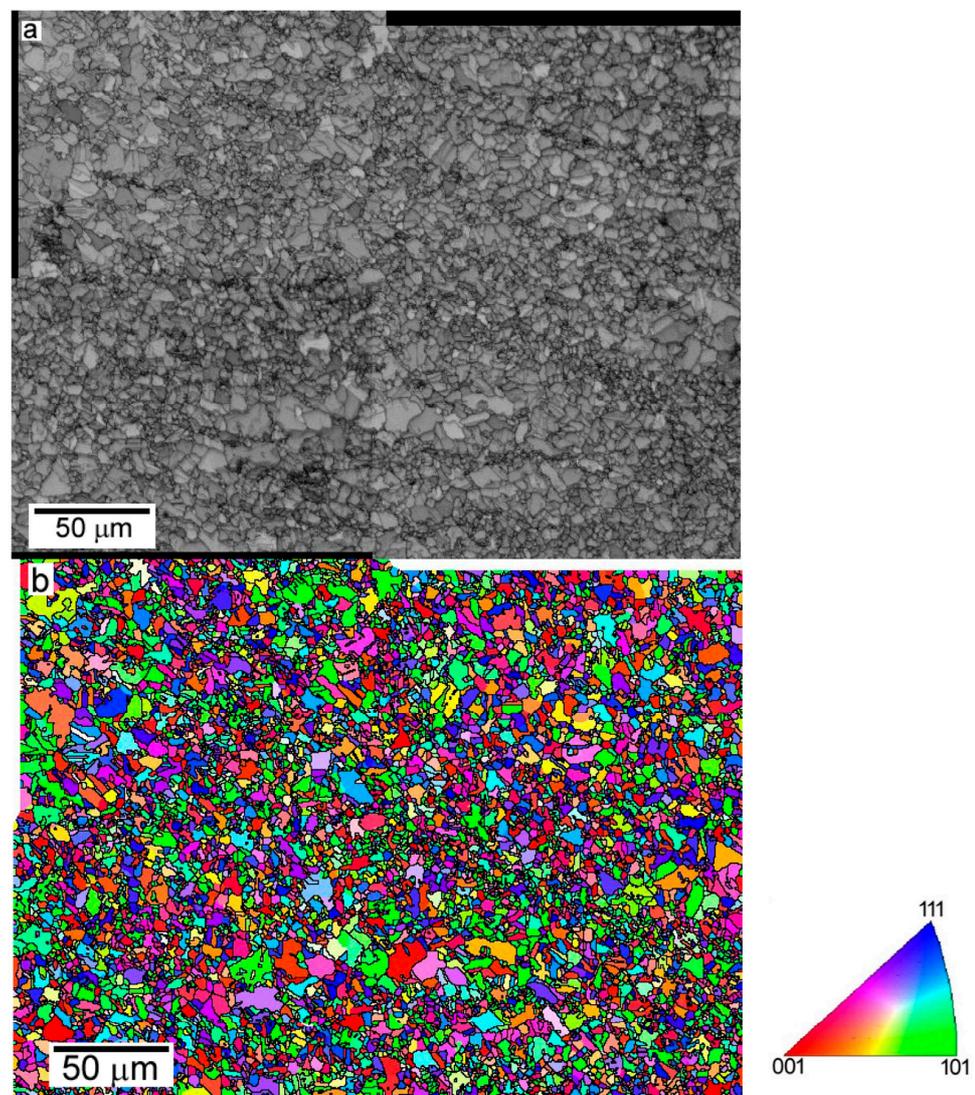


Figure 10. Microstructure of the CR + TT700 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $316 \times 241 \mu\text{m}^2$, and the step size is $0.5 \mu\text{m}$.

The microstructures of the alloys annealed at 800, 850, 900 and 950 °C for 1 h are presented from Figures 11–15. The microstructure is similar at all temperatures, although

the higher the temperature is the coarser the grain size is. As found after annealing at 700 °C, the microstructure is always bimodal, combining coarse- and fine-grained areas. This suggests an identical mechanism for developing this bimodal recrystallized microstructure. The grain size of coarse-grained areas ranges between 10 and 25 µm at 800 °C, 20 and 60 µm at 850 °C, 25 and 60 at 900 °C and 50–60 µm at 950 °C. On the other hand, the grain size of fine-grained regions shifts between 2 and 7 µm at 800 °C, 3 and 10 µm at 850 °C, 15 and 30 µm at 900 °C and 20 and 40 µm at 950 °C. The evolution of the grain size with the annealing temperature evidences that grain growth is rapidly saturated in coarse-grained regions. The maximum grain size of statically recrystallized grains hardly increases beyond 850 °C, with a maximum value of about 60 µm. This means that grain growth above 850 °C is mainly restricted to fine-grained regions. This indicates a lower driving force for grain growth in these regions because of the low dislocation density and the reduction in grain boundary energy related to the progressive decrease in the total grain boundary area. Oppositely, grain growth is favored in fine-grained regions because the large grain boundary area provides the driving force necessary for decreasing the surface energy in these regions. Thus, the grain size of fine-grained regions tends to approach the grain size of coarse-grained regions with the increasing annealing temperature.

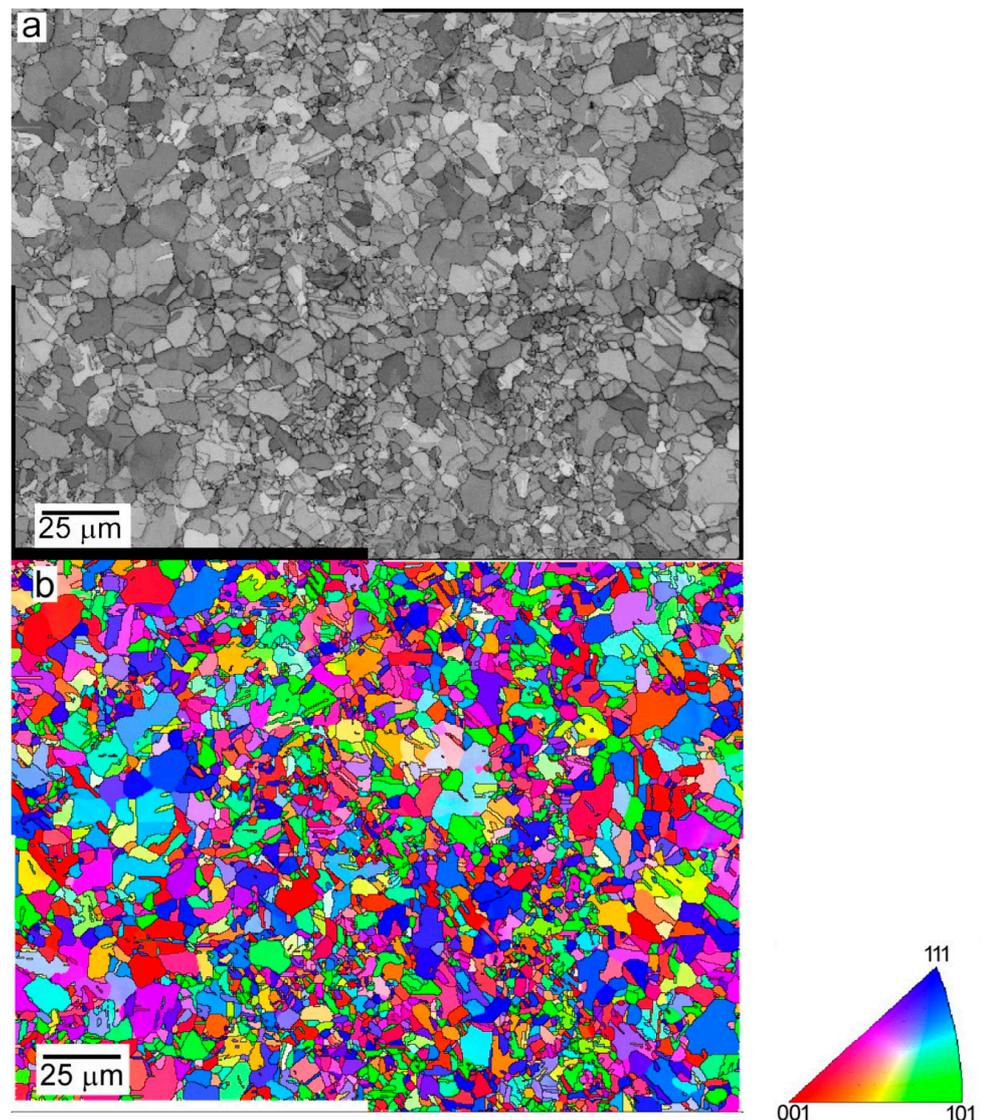


Figure 11. Microstructure of the CR + TT800 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $236 \times 179 \mu\text{m}^2$, and the step size is $0.4 \mu\text{m}$.

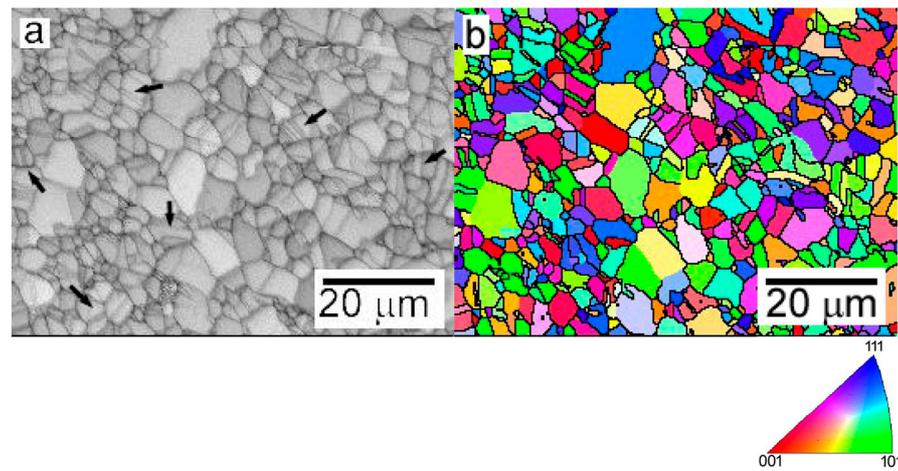


Figure 12. Microstructure representative of fine-grained regions of CR + TT850 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $80 \times 60 \mu\text{m}^2$, and the step size is $0.3 \mu\text{m}$. The black arrows indicate examples of recrystallization twins.

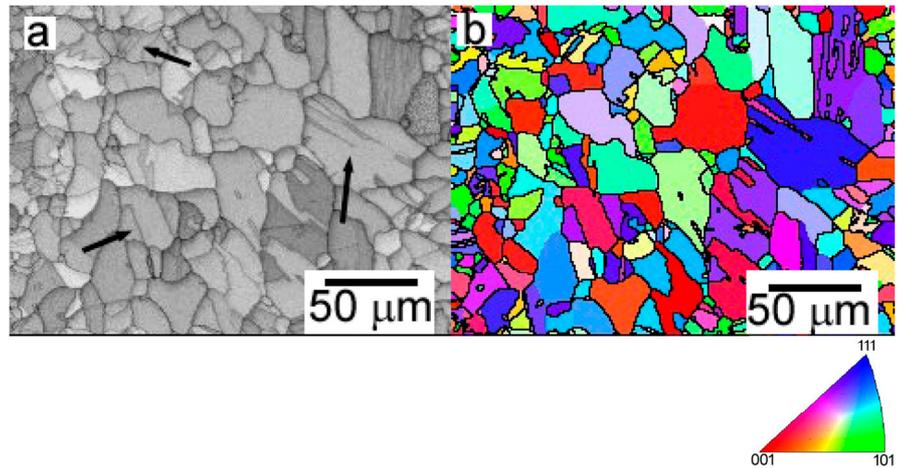


Figure 13. Microstructure representative of coarse-grained regions of the CR + TT850 HEA. (a) IQ, (b) IPF + IQ map. The scanned area is $239 \times 180 \mu\text{m}^2$, and the step size is $1 \mu\text{m}$. The black arrows indicate examples of recrystallization twins.

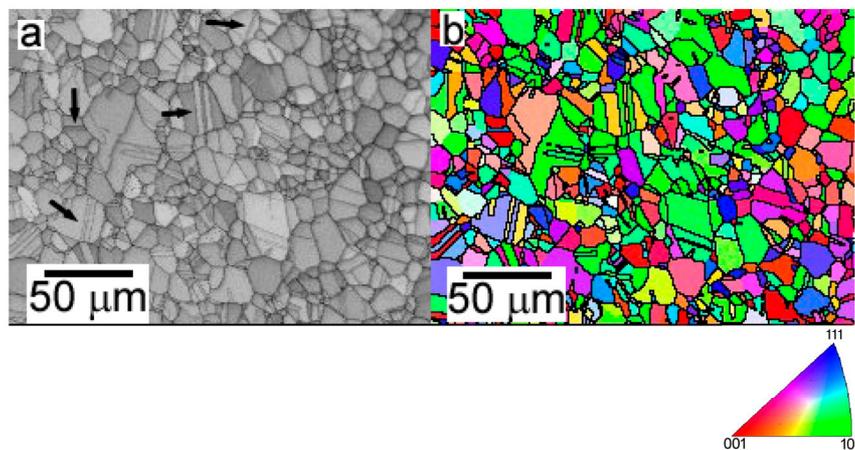


Figure 14. Microstructure representative of the CR + TT900. (a) IQ, (b) IPF + IQ map. The scanned area is $239 \times 180 \mu\text{m}^2$, and the step size is $1 \mu\text{m}$. The black arrows indicate examples of recrystallization twins.

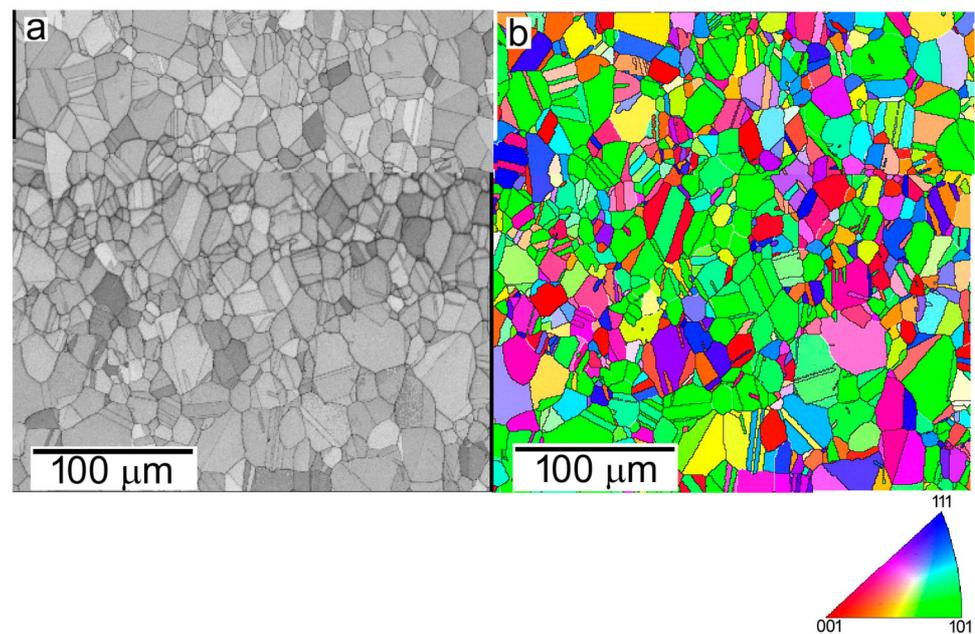


Figure 15. Microstructure representative of the CR + TT950. (a) IQ, (b) IPF + IQ map. The scanned area is $302 \times 316 \mu\text{m}^2$, and the step size is $0.8 \mu\text{m}$.

3.4. Microhardness

The Vickers microhardness values for all the studied materials are shown in Table 4. It can be checked that the hardness of the thermo-mechanically processed alloys increases with decreasing the temperature of processing, attaining a maximum of 363 HV for the WR450-2 alloy. In the case of the annealed alloys, the microhardness increases, compared with the CR alloy, as the annealing temperature increases, with a maximum value at $500 \text{ }^\circ\text{C}$. Only at temperatures above $600 \text{ }^\circ\text{C}$, the microhardness drops to very small values. A similar behavior has been reported for other HEAs [21,26]. Therefore, recrystallization and subsequent grain growth of the CR material induce considerable softening, which becomes higher as the grain size of the alloy increases. If a given temperature is considered, the microhardness of the material thermo-mechanically treated is higher than that of the annealed material. Thus, hardness of the HR850-6 alloy is almost two times that of the CR + TT850 alloy. Moreover, an increase in rolling reduction at $850 \text{ }^\circ\text{C}$ also causes an increase of about 40 HV for the HR850-2 alloy compared to HR850-6 alloy. Consequently, the differences in hardness have to be correlated with changes in the dislocation density existing in the materials, which is very high in the case of thermo-mechanically processed alloys while statically recrystallized alloys resulting from annealing treatments are almost totally free of dislocations. It is interesting to note that microhardness of the WR450-2 is higher than that of the CR alloy. This behavior could be also connected with the anomalous increase in microhardness measured in the alloy annealed from 400 to $600 \text{ }^\circ\text{C}$ with respect to the CR alloy. It was proposed that such an increase is associated with solute segregation to stacking faults and short-range ordering [26]. To check this point, differential scanning calorimetry (DSC) tests in the CR material were carried out at heating rates from 40 to $70 \text{ }^\circ\text{C}/\text{min}$. Three peaks can be clearly observed in the DSC curve, as shown in Figure 16. The first one can be identified between 225 and $300 \text{ }^\circ\text{C}$. The nature of microstructural changes associated with this first peak is not clear, but it could be associated with recovery processes occurring in the crystalline lattice through the elimination or rearrangement of defects such as vacancies or dislocations generated during cold rolling as a way for reducing the stored energy in the CR microstructure. The second one between 350 and $450 \text{ }^\circ\text{C}$ agrees rather well with the increase in hardness measured in the CR alloy annealed at 400 and $500 \text{ }^\circ\text{C}$ and the WR450-2 alloy. This interval of temperatures coincides also with that reported for the occurrence of the dynamic strain-ageing phenomenon in other HEAs [27,28]. Therefore, it is reasonable to

assume that during thermo-mechanical processing and/or annealing within this range of temperatures, solute atoms can diffuse to the core of dislocations, pinning their movement, which results in an increase in hardness. It is evident that the third peak between 550 and 650 °C corresponds to recrystallization.

Table 4. Influence of thermomechanical processing and annealing temperature on the Vickers microhardness of thermo-mechanically and thermally treated $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ HEA.

Material	Microhardness Vickers (kg/mm^2)
As cast	121 ± 5
FG1200	157 ± 6
HR850-6	267 ± 2
HR850-2	309 ± 5
WR450-2	363 ± 5
CR	318 ± 9
CR + TT400	342 ± 9
CR + TT500	380 ± 6
CR + TT600	339 ± 12
CR + TT700	203 ± 6
CR + TT800	190 ± 8
CR + TT850	165 ± 4
CR + TT900	144 ± 2
CR + TT950	127 ± 3

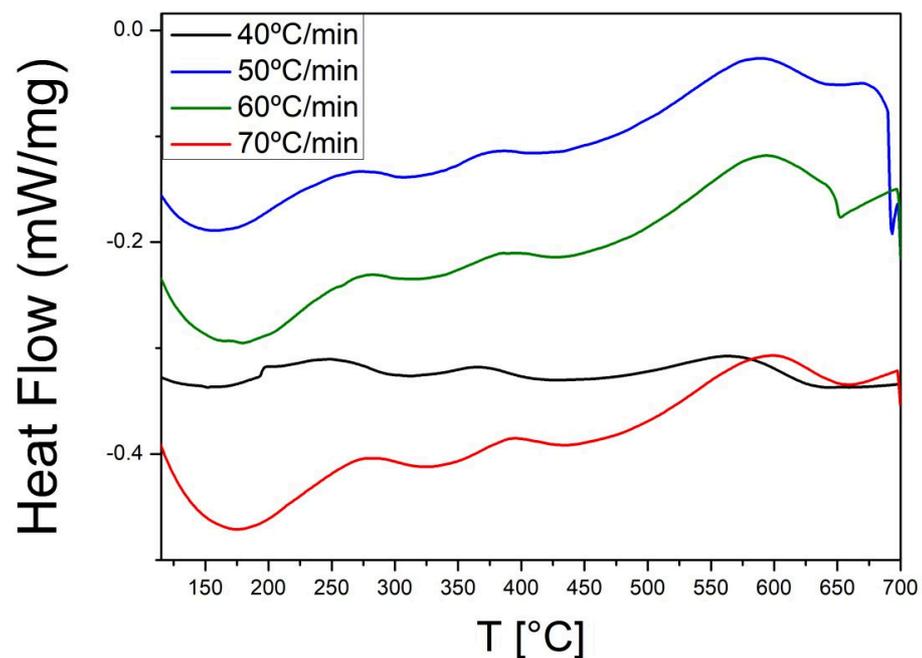


Figure 16. DSC curves of the CR alloy at heating rates of 40, 50, 60 and 70 °C/min.

4. Conclusions

From the present study, the following conclusions can be drawn:

- (1) The microstructure of the single-phase fcc-based $\text{Al}_5\text{Co}_{15}\text{Cr}_{30}\text{Fe}_{25}\text{Ni}_{25}$ HEA can be tuned through the proper choice of the thermo-mechanical processing and thermal treatments in such a way that hardness can be increased up to three times that of the as-cast alloy.
- (2) The occurrence or not of recrystallization during thermo-mechanical and annealing treatments determines the mechanical strength of the HEA. Complete recrystallization of annealed samples is attained after 1 h of exposure at 700 °C, inducing considerable softening.

- (3) The degree of recrystallization during thermo-mechanical processing of Al₅Co₁₅Cr₃₀Fe₂₅Ni₂₅ HEA depends on the reduction applied to the material and the orientation of parent grains in the as-cast alloy.
- (4) Maximum hardening is found for the alloy warm rolled at 450 °C and the cold-rolled alloy annealed at 500 °C for 1 h. This indicates that thermo-mechanical processing or annealing treatments below 600 °C induce an additional hardening associated with the pinning effect of solute atoms located at the core of dislocations.

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